



DMN3042LFDF

## **Product Summary**

BV <sub>DSS</sub>	Rds(on) Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
	28mΩ @ V <sub>GS</sub> = 10V	7.0A
30V	32mΩ @ V <sub>GS</sub> = 4.5V	6.5A

# **Description and Applications**

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- General Purpose Interfacing Switch
- Power Management Functions

#### 30V N-CHANNEL ENHANCEMENT MODE MOSFET

### **Features and Benefits**

- 0.6mm Profile Ideal for Low Profile Applications
- PCB Footprint of 4mm<sup>2</sup>
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

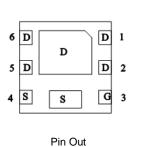
### **Mechanical Data**

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 Per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @
- Weight: 0.007 grams (Approximate)

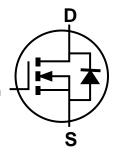
U-DFN2020-6 (Type F)

Top View

Bottom View



Bottom View



Internal Schematic

## Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3042LFDF-7	U-DFN2020-6 (Type F)	3,000/Tape & Reel
DMN3042LFDF-13	U-DFN2020-6 (Type F)	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



## **Marking Information**

Site 1



S7 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020)M = Month (ex: 9 = September)

Date	Code	Key

Year	2016		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
Code	D		Н	I	J	K	L	М	Ν	0	Р	R
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Site 2



S7 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 0 = 2020) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

### Date Code Key

Da	Dale Code Key												
	Year	2016		2020	2021	2022	2023	2024	2025	2026	2027	2028	2029
	Code	6		0	1	2	3	4	5	6	7	8	9

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	Т	U	V	W	Х	Y	Z



#### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			Vdss	30	V
Gate-Source Voltage			V <sub>GSS</sub>	±12	V
Continuous Drain Current (Note 6) $V_{GS}$ = 10V	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +70°C	lo	7.0 5.6	А
Maximum Continuous Body Diode Forward Curre	ent (Note 6)		ls	1.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle =	1%)		ldм	35	А
Avalanche Current (L = 0.1mH) (Note 7)		las	13	А	
Avalanche Energy (L = 0.1mH) (Note 7)			Eas	9	mJ

## **Thermal Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	0.7	W	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	P	177	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	RθJA	124	C/vv	
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	2.1	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	61	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	R <sub>θJA</sub>	43	C/W	
Thermal Resistance, Junction to Case	Steady State	R <sub>θJC</sub>	9.3	°C/W	
Operating and Storage Temperature Range		TJ. TSTG	-55 to +150	°C	

#### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)	Symbol	IVIIII	тур	IVIAA	Unit	Test condition
Drain-Source Breakdown Voltage	BVDSS	30	_	_	V	$V_{GS} = 0V, I_{D} = 250 \mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	lgss	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.6	—	1.4	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		_	17	28		$V_{GS} = 10V, I_{D} = 4.0A$
Static Drain-Source On-Resistance	Deserve	_	20	32	mΩ	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 4.0A
Static Drain-Source On-Resistance	RDS(ON)	_	24	42	11175	V <sub>GS</sub> = 3.0V, I <sub>D</sub> = 4.0A
		_	28	50		Vgs = 2.5V, ID = 4.0A
Diode Forward Voltage	V <sub>SD</sub>	_	0.7	1.2	V	$V_{GS} = 0V, I_S = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss		570	—		
Output Capacitance	Coss		63	—	pF	Vps = 15V, Vgs = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss	—	53	—		
Gate Resistance	Rg	_	3.2	—	Ω	V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1.0MHz
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	—	13.3	—		
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	6.1	—	nC	
Gate-Source Charge	Qgs	_	1.0	—	nc	$V_{DS} = 15V, I_D = 6.9A$
Gate-Drain Charge	Q <sub>gd</sub>	—	1.6	—		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	1.5	—		
Turn-On Rise Time	tR	_	3.3	—		$V_{GS} = 10V, V_{DD} = 15V, R_{g} = 3\Omega,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>		13.9	—	ns	I <sub>D</sub> = 6.9A
Turn-Off Fall Time	tF		4.9	—	1	
Body Diode Reverse Recovery Time	trr		7.8	—	ns	Is = 5A, dl/dt = 100A/µs
Body Diode Reverse Recovery Charge	Qrr		1.9	—	nC	Is = 5A, dl/dt = 100A/µs

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

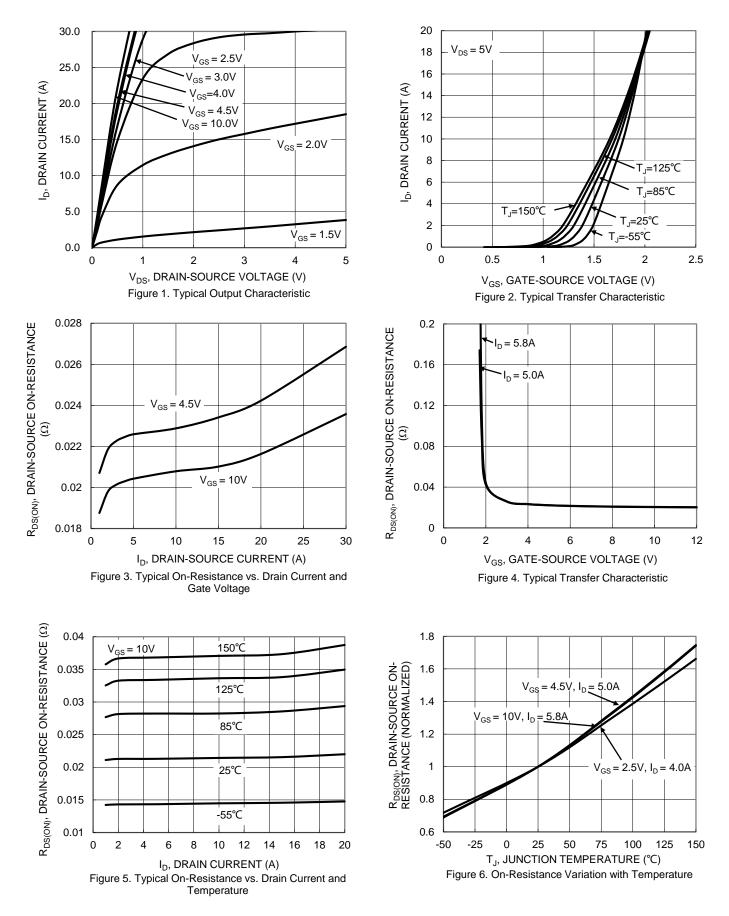
7.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J = +25^{\circ}C$ .

8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.



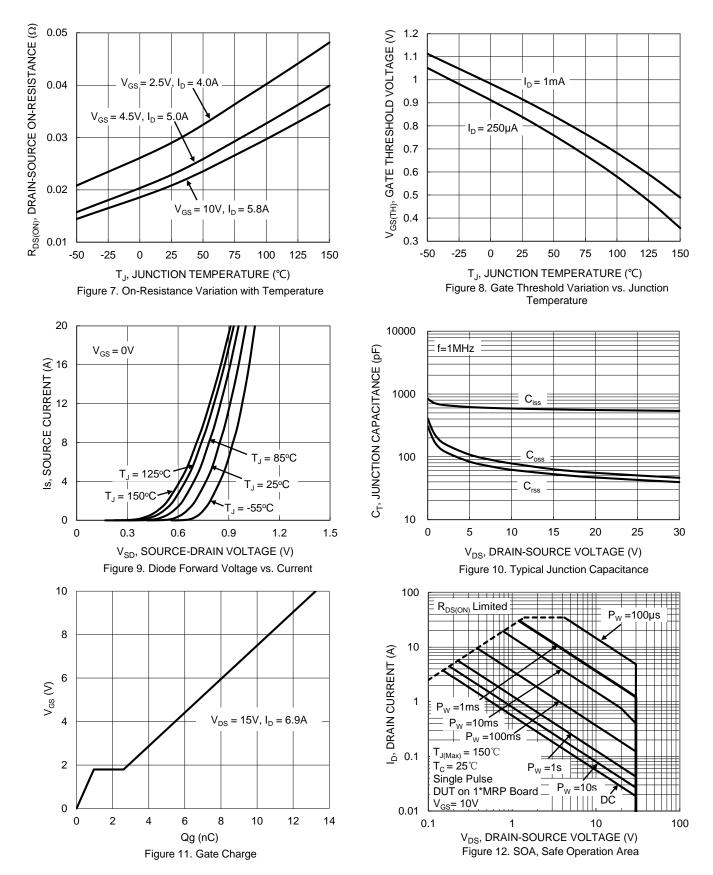
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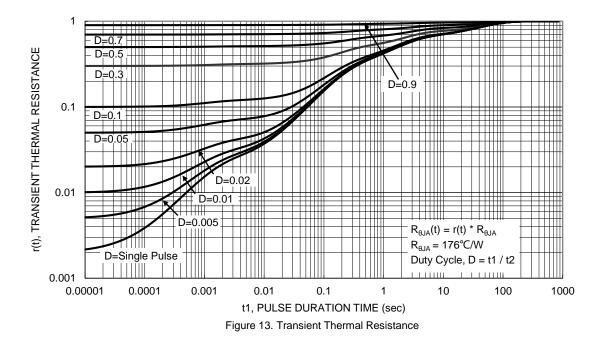
DMN3042LFDF Datasheet number: DS38985 Rev. 2 - 2



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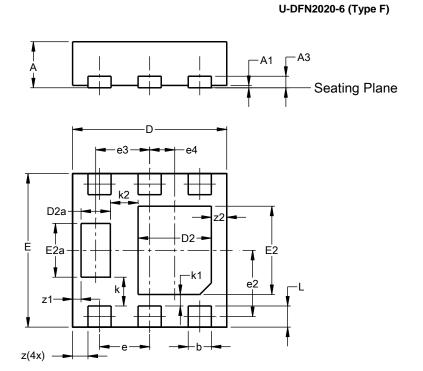






## **Package Outline Dimensions**

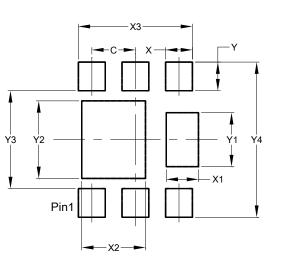
Please see http://www.diodes.com/package-outlines.html for the latest version.



	U-DFN2020-6 (Type F)								
Dim	Min Max Typ								
Α	0.57	0.63	0.60						
A1	0.00	0.05	0.03						
A3	-	-	0.15						
b	0.25	0.35	0.30						
D	1.95	2.05	2.00						
D2	0.85	1.05	0.95						
D2a	0.33	0.43	0.38						
E	1.95	2.05	2.00						
E2	1.05	1.25	1.15						
E2a	0.65	0.75	0.70						
е	Ť	0.65 BS	С						
e2	C	).863 BS	SC						
e3	ł	0.70 BS	С						
e4	C	).325 BS	SC						
k	ł	0.37 BS	С						
k1		0.15 BS	С						
k2	Ť	0.36 BS	С						
L	0.225	0.325	0.275						
z		0.20 BS	С						
z1	C	).110 BS	SC						
z2		0.20 BS	С						
All D	Dimens	ions in	mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Value (in mm)
0.650
0.400
0.480
0.950
1.700
0.425
0.800
1.150

Y3

Y4

1.450

2.300

#### U-DFN2020-6 (Type F)



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